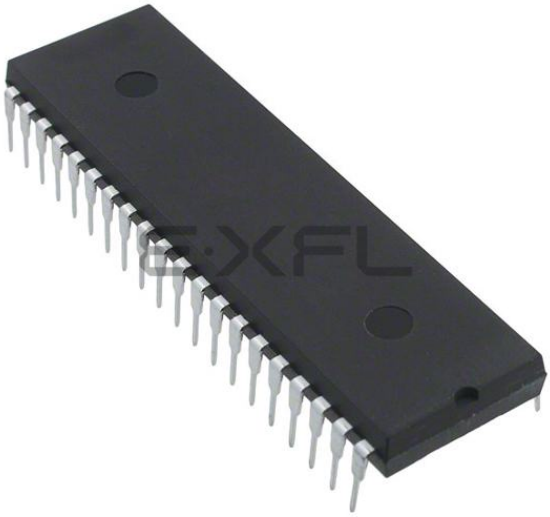


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	25MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	36
Program Memory Size	4KB (2K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	4.2V ~ 5.5V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Through Hole
Package / Case	40-DIP (0.600", 15.24mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f4220-e-p

5.8 Look-up Tables

Look-up tables are implemented two ways:

- Computed GOTO
- Table Reads

5.8.1 COMPUTED GOTO

A computed GOTO is accomplished by adding an offset to the program counter. An example is shown in Example 5-4.

A look-up table can be formed with an ADDWF PCL instruction and a group of RETLW 0xnn instructions. WREG is loaded with an offset into the table before executing a call to that table. The first instruction of the called routine is the ADDWF PCL instruction. The next instruction executed will be one of the RETLW 0xnn instructions that returns the value 0xnn to the calling function.

The offset value (in WREG) specifies the number of bytes that the program counter should advance and should be multiples of 2 (LSB = 0).

In this method, only one data byte may be stored in each instruction location and room on the return address stack is required.

EXAMPLE 5-4: COMPUTED GOTO USING AN OFFSET VALUE

```
        MOVFW   OFFSET
        CALL    TABLE
ORG     0xnn00
TABLE   ADDWF   PCL
        RETLW   0xnn
        RETLW   0xnn
        RETLW   0xnn
        •
        •
        •
```

5.8.2 TABLE READS/TABLE WRITES

A better method of storing data in program memory allows two bytes of data to be stored in each instruction location.

Look-up table data may be stored two bytes per program word by using table reads and writes. The Table Pointer (TBLPTR) specifies the byte address and the Table Latch (TABLAT) contains the data that is read from, or written to program memory. Data is transferred to/from program memory, one byte at a time.

The Table Read/Table Write operation is discussed further in **Section 6.1 "Table Reads and Table Writes"**.

5.9 Data Memory Organization

The data memory is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. Figure 5-6 shows the data memory organization for the PIC18F2X20/4X20 devices.

The data memory map is divided into as many as 16 banks that contain 256 bytes each. The lower 4 bits of the Bank Select Register (BSR<3:0>) select which bank will be accessed. The upper 4 bits of the BSR are not implemented.

The data memory contains Special Function Registers (SFR) and General Purpose Registers (GPR). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratch pad operations in the user's application. The SFRs start at the last location of Bank 15 (FFFh) and extend towards F80h. Any remaining space beyond the SFRs in the bank may be implemented as GPRs. GPRs start at the first location of Bank 0 and grow upwards. Any read of an unimplemented location will read as '0's.

The entire data memory may be accessed directly or indirectly. Direct addressing may require the use of the BSR register. Indirect addressing requires the use of a File Select Register (FSRn) and a corresponding Indirect File Operand (INDFn). Each FSR holds a 12-bit address value that can be used to access any location in the data memory map without banking. See **Section 5.12 "Indirect Addressing, INDF and FSR Registers"** for indirect addressing details.

The instruction set and architecture allow operations across all banks. This may be accomplished by indirect addressing or by the use of the MOVFF instruction. The MOVFF instruction is a two-word/two-cycle instruction that moves a value from one register to another.

To ensure that commonly used registers (SFRs and select GPRs) can be accessed in a single cycle, regardless of the current BSR values, an Access Bank is implemented. A segment of Bank 0 and a segment of Bank 15 comprise the Access RAM. **Section 5.10 "Access Bank"** provides a detailed description of the Access RAM.

5.9.1 GENERAL PURPOSE REGISTER FILE

Enhanced MCU devices may have banked memory in the GPR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

Data RAM is available for use as GPR registers by all instructions. The second half of Bank 15 (F80h to FFFh) contains SFRs. All other banks of data memory contain GPRs, starting with Bank 0.

Example 8-3 shows the sequence to do a 16 x 16 unsigned multiply. Equation 8-1 shows the algorithm that is used. The 32-bit result is stored in four registers, RES3:RES0.

EQUATION 8-1: 16 x 16 UNSIGNED MULTIPLICATION ALGORITHM

$$
\begin{aligned}
RES3:RES0 &= ARG1H:ARG1L \bullet ARG2H:ARG2L \\
&= (ARG1H \bullet ARG2H \bullet 2^{16}) + \\
&\quad (ARG1H \bullet ARG2L \bullet 2^{8}) + \\
&\quad (ARG1L \bullet ARG2H \bullet 2^{8}) + \\
&\quad (ARG1L \bullet ARG2L)
\end{aligned}
$$

EXAMPLE 8-3: 16 x 16 UNSIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L         ; ARG1L * ARG2L ->
                          ; PRODH:PRODL
    MOVFF   PRODH, RES1   ;
    MOVFF   PRODL, RES0   ;
;
    MOVF    ARG1H, W
    MULWF   ARG2H         ; ARG1H * ARG2H ->
                          ; PRODH:PRODL
    MOVFF   PRODH, RES3   ;
    MOVFF   PRODL, RES2   ;
;
    MOVF    ARG1L, W
    MULWF   ARG2H         ; ARG1L * ARG2H ->
                          ; PRODH:PRODL
    MOVF    PRODL, W      ;
    ADDWF   RES1, F       ; Add cross
    MOVF    PRODH, W      ; products
    ADDWFC  RES2, F       ;
    CLRF    WREG          ;
    ADDWFC  RES3, F       ;
;
    MOVF    ARG1H, W      ;
    MULWF   ARG2L         ; ARG1H * ARG2L ->
                          ; PRODH:PRODL
    MOVF    PRODL, W      ;
    ADDWF   RES1, F       ; Add cross
    MOVF    PRODH, W      ; products
    ADDWFC  RES2, F       ;
    CLRF    WREG          ;
    ADDWFC  RES3, F       ;
```

Example 8-4 shows the sequence to do a 16 x 16 signed multiply. Equation 8-2 shows the algorithm used. The 32-bit result is stored in four registers, RES3:RES0. To account for the sign bits of the arguments, each argument pairs' Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EQUATION 8-2: 16 x 16 SIGNED MULTIPLICATION ALGORITHM

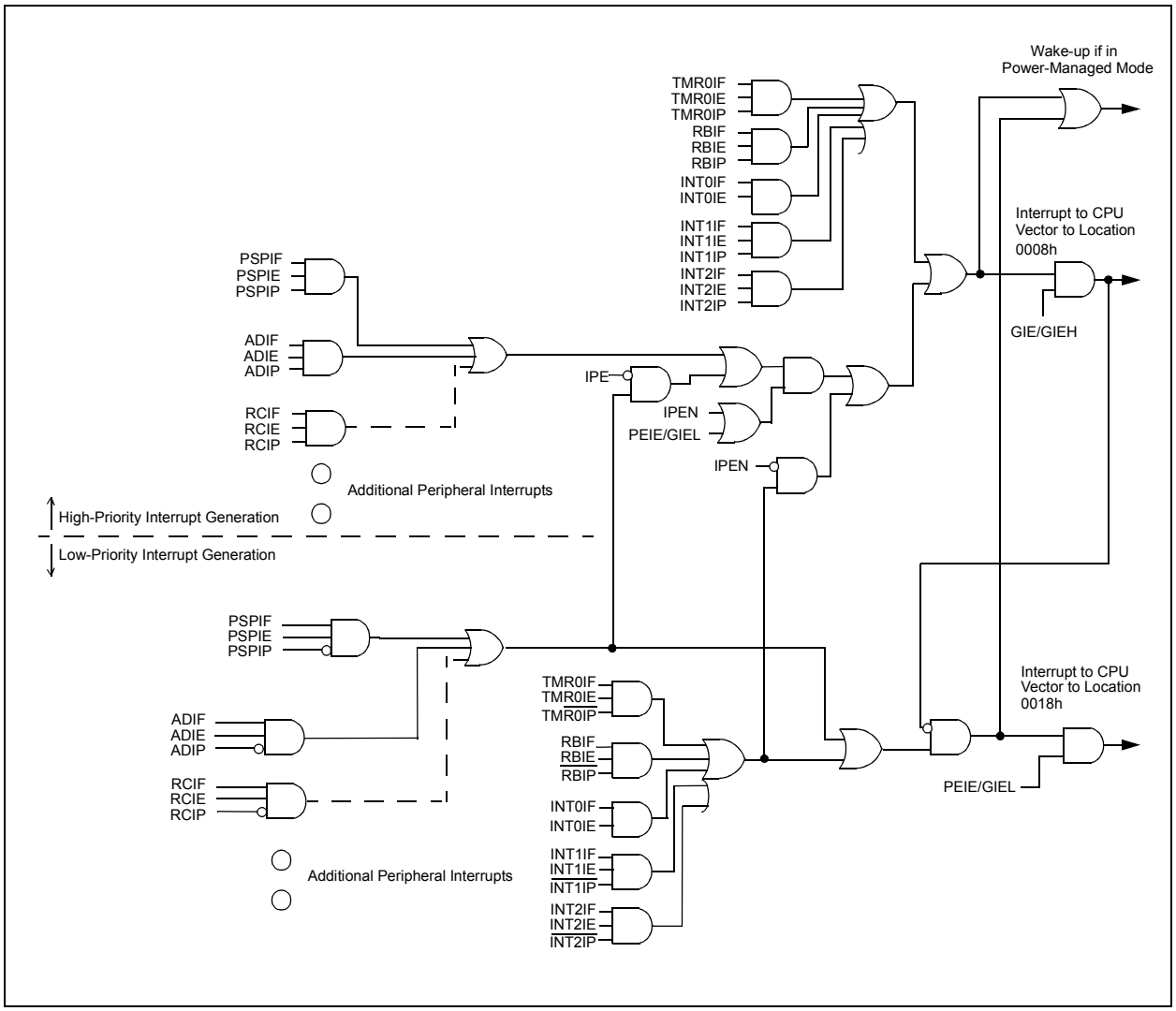
$$
\begin{aligned}
RES3:RES0 &= ARG1H:ARG1L \bullet ARG2H:ARG2L \\
&= (ARG1H \bullet ARG2H \bullet 2^{16}) + \\
&\quad (ARG1H \bullet ARG2L \bullet 2^{8}) + \\
&\quad (ARG1L \bullet ARG2H \bullet 2^{8}) + \\
&\quad (ARG1L \bullet ARG2L) + \\
&\quad (-1 \bullet ARG2H\langle 7\rangle \bullet ARG1H:ARG1L \bullet 2^{16}) + \\
&\quad (-1 \bullet ARG1H\langle 7\rangle \bullet ARG2H:ARG2L \bullet 2^{16})
\end{aligned}
$$

EXAMPLE 8-4: 16 x 16 SIGNED MULTIPLY ROUTINE

```
    MOVF    ARG1L, W
    MULWF   ARG2L         ; ARG1L * ARG2L ->
                          ; PRODH:PRODL
    MOVFF   PRODH, RES1   ;
    MOVFF   PRODL, RES0   ;
;
    MOVF    ARG1H, W
    MULWF   ARG2H         ; ARG1H * ARG2H ->
                          ; PRODH:PRODL
    MOVFF   PRODH, RES3   ;
    MOVFF   PRODL, RES2   ;
;
    MOVF    ARG1L, W
    MULWF   ARG2H         ; ARG1L * ARG2H ->
                          ; PRODH:PRODL
    MOVF    PRODL, W      ;
    ADDWF   RES1, F       ; Add cross
    MOVF    PRODH, W      ; products
    ADDWFC  RES2, F       ;
    CLRF    WREG          ;
    ADDWFC  RES3, F       ;
;
    MOVF    ARG1H, W      ;
    MULWF   ARG2L         ; ARG1H * ARG2L ->
                          ; PRODH:PRODL
    MOVF    PRODL, W      ;
    ADDWF   RES1, F       ; Add cross
    MOVF    PRODH, W      ; products
    ADDWFC  RES2, F       ;
    CLRF    WREG          ;
    ADDWFC  RES3, F       ;
;
    BTFSS   ARG2H, 7      ; ARG2H:ARG2L neg?
    BRA     SIGN_ARG1     ; no, check ARG1
    MOVF    ARG1L, W      ;
    SUBWF   RES2          ;
    MOVF    ARG1H, W      ;
    SUBWFB  RES3
;
SIGN_ARG1
    BTFSS   ARG1H, 7      ; ARG1H:ARG1L neg?
    BRA     CONT_CODE     ; no, done
    MOVF    ARG2L, W      ;
    SUBWF   RES2          ;
    MOVF    ARG2H, W      ;
    SUBWFB  RES3
;
CONT_CODE
   :
```


© 2007 Microchip Technology Inc.

FIGURE 9-1: INTERRUPT LOGIC



© 2007 Microchip Technology Inc.

REGISTER 9-3: INTCON3: INTERRUPT CONTROL REGISTER 3

R/W-1	R/W-1	U-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0
INT2IP	INT1IP	—	INT2IE	INT1IE	—	INT2IF	INT1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **INT2IP:** INT2 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 6 **INT1IP:** INT1 External Interrupt Priority bit
1 = High priority
0 = Low priority

bit 5 **Unimplemented:** Read as '0'

bit 4 **INT2IE:** INT2 External Interrupt Enable bit
1 = Enables the INT2 external interrupt
0 = Disables the INT2 external interrupt

bit 3 **INT1IE:** INT1 External Interrupt Enable bit
1 = Enables the INT1 external interrupt
0 = Disables the INT1 external interrupt

bit 2 **Unimplemented:** Read as '0'

bit 1 **INT2IF:** INT2 External Interrupt Flag bit
1 = The INT2 external interrupt occurred (must be cleared in software)
0 = The INT2 external interrupt did not occur

bit 0 **INT1IF:** INT1 External Interrupt Flag bit
1 = The INT1 external interrupt occurred (must be cleared in software)
0 = The INT1 external interrupt did not occur

Note: Interrupt flag bits are set when an interrupt condition occurs regardless of the state of its corresponding enable bit or the global enable bit. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt. This feature allows for software polling.

10.0 I/O PORTS

Depending on the device selected and features enabled, there are up to five ports available. Some pins of the I/O ports are multiplexed with an alternate function from the peripheral features on the device. In general, when a peripheral is enabled, that pin may not be used as a general purpose I/O pin.

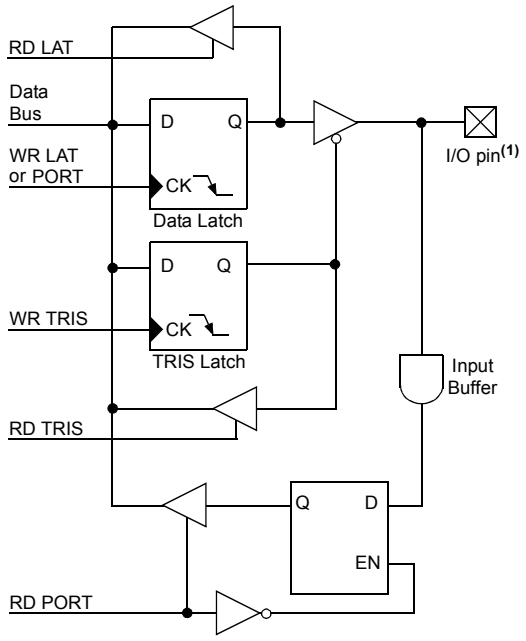
Each port has three registers for its operation. These registers are:

- TRIS register (Data Direction register)
- PORT register (reads the levels on the pins of the device)
- LAT register (Data Latch)

The Data Latch (LAT register) is useful for read-modify-write operations on the value that the I/O pins are driving.

A simplified model of a generic I/O port without the interfaces to other peripherals is shown in Figure 10-1.

FIGURE 10-1: GENERIC I/O PORT OPERATION



Note 1: I/O pins have diode protection to VDD and VSS.

10.1 PORTA, TRISA and LATA Registers

PORTA is an 8-bit wide, bidirectional port. The corresponding Data Direction register is TRISA. Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., put the corresponding output driver in a high-impedance mode). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., put the contents of the output latch on the selected pin).

Reading the PORTA register reads the status of the pins, whereas writing to it, will write to the port latch.

The Data Latch register (LATA) is also memory mapped. Read-modify-write operations on the LATA register read and write the latched output value for PORTA.

The RA4 pin is multiplexed with the Timer0 module clock input and one of the comparator outputs to become the RA4/T0CKI/C1OUT pin. Pins RA6 and RA7 are multiplexed with the main oscillator pins; they are enabled as oscillator or I/O pins by the selection of the main oscillator in Configuration Register 1H (see **Section 23.1 "Configuration Bits"** for details). When they are not used as port pins, RA6 and RA7 and their associated TRIS and LAT bits are read as '0'.

The other PORTA pins are multiplexed with analog inputs, the analog VREF+ and VREF- inputs and the comparator voltage reference output. The operation of pins, RA3:RA0 and RA5, as A/D converter inputs is selected by clearing/setting the control bits in the ADCON1 register (A/D Control Register 1). Pins RA0 through RA5 may also be used as comparator inputs or outputs by setting the appropriate bits in the CMCON register.

Note:	On a Power-on Reset, RA5 and RA3:RA0 are configured as analog inputs and read as '0'. RA4 is configured as a digital input.

The RA4/T0CKI/C1OUT pin is a Schmitt Trigger input and an open-drain output. All other PORTA pins have TTL input levels and full CMOS output drivers.

The TRISA register controls the direction of the RA pins even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs.

EXAMPLE 10-1: INITIALIZING PORTA

```
CLRF    PORTA   ;   Initialize PORTA by
                ;   clearing output
                ;   data latches
CLRF    LATA    ;   Alternate method
                ;   to clear output
                ;   data latches
MOVLW   0x0F    ;   Set all A/D pins as
MOVWF   ADCON1  ;   digital I/O pins
MOVLW   0xCF    ;   Value used to
                ;   initialize data
                ;   direction
MOVWF   TRISA   ;   Set RA<3:0> as inputs
                ;   RA<5:4> as outputs
```

TABLE 10-9: PORTE FUNCTIONS

Name	Bit#	Buffer Type	Function
RE0/AN5/$\overline{RD}$	bit 0	ST/TTL(1)	Input/output port pin, analog input or read control input in Parallel Slave Port mode. For $\overline{RD}$ (PSP Control mode): 1 = PSP is Idle 0 = Read operation. Reads PORTD register (if chip selected).
RE1/AN6/$\overline{WR}$	bit 1	ST/TTL(1)	Input/output port pin, analog input or write control input in Parallel Slave Port mode. For $\overline{WR}$ (PSP Control mode): 1 = PSP is Idle 0 = Write operation. Writes PORTD register (if chip selected).
RE2/AN7/$\overline{CS}$	bit 2	ST/TTL(1)	Input/output port pin, analog input or chip select control input in Parallel Slave Port mode. For $\overline{CS}$ (PSP Control mode): 1 = PSP is Idle 0 = External device is selected
$\overline{MCLR}$/VPP/RE3(2)	bit 3	ST	Input only port pin or programming voltage input (if $\overline{MCLR}$ is disabled); Master Clear input or programming voltage input (if $\overline{MCLR}$ is enabled).

Legend: ST = Schmitt Trigger input, TTL = TTL input

Note 1: Input buffers are Schmitt Triggers when in I/O mode and TTL buffers when in Parallel Slave Port mode.

2: The RE3 port bit is available as an input-only pin only in 40-pin devices and when Master Clear functionality is disabled (CONFIG3H<7>=0).

TABLE 10-10: SUMMARY OF REGISTERS ASSOCIATED WITH PORTE

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	Value on all other Resets
PORTE	—	—	—	—	RE3(1)	RE2	RE1	RE0	---- qxxx	---- quuu
LATE	—	—	—	—	—	LATE Data Latch Register			---- -xxx	---- -uuu
TRISE	IBF	OBF	IBOV	PSPMODE	—	PORTE Data Direction bits			0000 -111	0000 -111
ADCON1	—	—	VCFG1	VCFG0	PCFG3	PCFG2	PCFG1	PCFG0	--00 0000	--00 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', q = value depends on condition.
Shaded cells are not used by PORTE.

Note 1: The RE3 port bit is available as an input-only pin only in 40-pin devices and when Master Clear functionality is disabled (CONFIG3H<7>=0).

15.5 PWM Mode

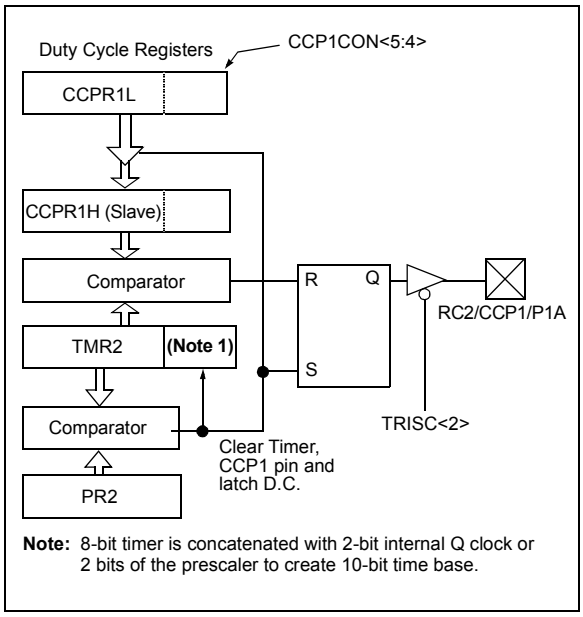
In Pulse Width Modulation (PWM) mode, the CCP1 pin produces up to a 10-bit resolution PWM output. Since the CCP1 pin is multiplexed with the PORTC data latch, the TRISC<2> bit must be cleared to make the CCP1 pin an output.

Note:	Clearing the CCP1CON register will force the CCP1 PWM output latch to the default low level. This is not the PORTC I/O data latch.

Figure 15-3 shows a simplified block diagram of the CCP module in PWM mode.

For a step-by-step procedure on how to set up the CCP module for PWM operation, see **Section 15.5.3 "Setup for PWM Operation"**.

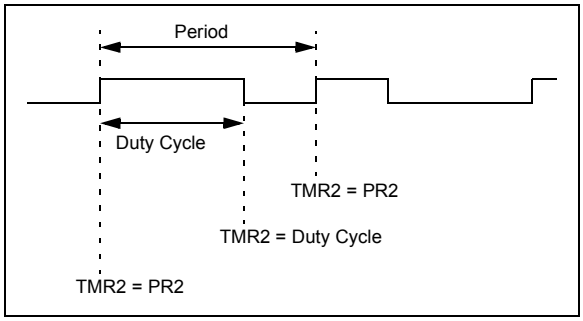
FIGURE 15-3: SIMPLIFIED PWM BLOCK DIAGRAM



Note: 8-bit timer is concatenated with 2-bit internal Q clock or 2 bits of the prescaler to create 10-bit time base.

A PWM output (Figure 15-4) has a time base (*period*) and a time that the output is high (*duty cycle*). The frequency of the PWM is the inverse of the period (1/period).

FIGURE 15-4: PWM OUTPUT



15.5.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register. The PWM period can be calculated using the following equation.

EQUATION 15-1:

$$\text{PWM Period} = [(PR2) + 1] \cdot 4 \cdot T_{OSC} \cdot (\text{TMR2 Prescale Value})$$

PWM frequency is defined as 1/[PWM period]. When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set (if PWM duty cycle = 0%, the CCP1 pin will not be set)
- The PWM duty cycle is copied from CCPR1L into CCPR1H

Note:	The Timer2 postscaler (see **Section 13.0 "Timer2 Module"**) is not used in the determination of the PWM frequency. The postscaler could be used to have a servo update rate at a different frequency than the PWM output.

15.5.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing to the CCPR1L register and to the CCP1CON<5:4> bits. Up to 10-bit resolution is available. The CCPR1L contains the eight MSbs and the CCP1CON<5:4> contains the two LSbs. This 10-bit value is represented by CCPR1L:CCP1CON<5:4>. The PWM duty cycle is calculated by the following equation.

EQUATION 15-2:

$$\text{PWM Duty Cycle} = (\text{CCPR1L:CCP1CON<5:4>}) \cdot T_{OSC} \cdot (\text{TMR2 Prescale Value})$$

CCPR1L and CCP1CON<5:4> can be written to at any time but the duty cycle value is not copied into CCPR1H until a match between PR2 and TMR2 occurs (i.e., the period is complete). In PWM mode, CCPR1H is a read-only register.

© 2007 Microchip Technology Inc.

REGISTER 16-3: ECCPAS: ENHANCED CAPTURE/COMPARE/PWM AUTO-SHUTDOWN CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPASE	ECCPAS2	ECCPAS1	ECCPAS0	PSSAC1	PSSAC0	PSSBD1	PSSBD0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ECCPASE:** ECCP Auto-Shutdown Event Status bit
1 = A shutdown event has occurred; ECCP outputs are in shutdown state
0 = ECCP outputs are operating

bit 6-4 **ECCPAS<2:0>:** ECCP Auto-Shutdown Source Select bits
000 = Auto-shutdown is disabled
001 = Comparator 1 output
010 = Comparator 2 output
011 = Either Comparator 1 or 2
100 = INT0
101 = INT0 or Comparator 1
110 = INT0 or Comparator 2
111 = INT0 or Comparator 1 or Comparator 2

bit 3-2 **PSSAC<1:0>:** Pin A and C Shutdown State Control bits
00 = Drive Pins A and C to '0'
01 = Drive Pins A and C to '1'
1x = Pins A and C tri-state

bit 1-0 **PSSBD<1:0>:** Pin B and D Shutdown State Control bits
00 = Drive Pins B and D to '0'
01 = Drive Pins B and D to '1'
1x = Pins B and D tri-state

© 2007 Microchip Technology Inc.

17.4.8 I²C MASTER MODE START CONDITION TIMING

To initiate a Start condition, the user sets the Start Condition Enable bit, SEN (SSPCON2<0>). If the SDA and SCL pins are sampled high, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and starts its count. If SCL and SDA are both sampled high when the Baud Rate Generator times out (TBRG), the SDA pin is driven low. The action of the SDA being driven low while SCL is high is the Start condition and causes the S bit (SSPSTAT<3>) to be set. Following this, the Baud Rate Generator is reloaded with the contents of SSPADD<6:0> and resumes its count. When the Baud Rate Generator times out (TBRG), the SEN bit (SSPCON2<0>) will be automatically cleared by hardware, the Baud Rate Generator is suspended, leaving the SDA line held low and the Start condition is complete.

Note:	If, at the beginning of the Start condition, the SDA and SCL pins are already sampled low or if during the Start condition, the SCL line is sampled low before the SDA line is driven low, a bus collision occurs, the Bus Collision Interrupt Flag, BCLIF, is set, the Start condition is aborted and the I²C module is reset into its Idle state.

17.4.8.1 WCOL Status Flag

If the user writes the SSPBUF when a Start sequence is in progress, the WCOL is set and the contents of the buffer are unchanged (the write doesn't occur).

Note:	Because queueing of events is not allowed, writing to the lower 5 bits of SSPCON2 is disabled until the Start condition is complete.

FIGURE 17-19: FIRST START BIT TIMING

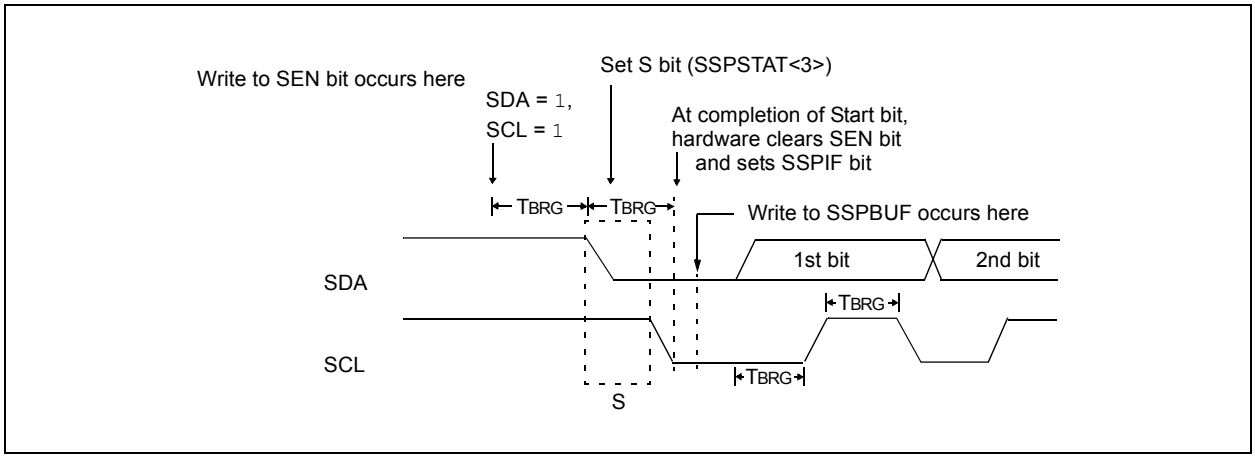
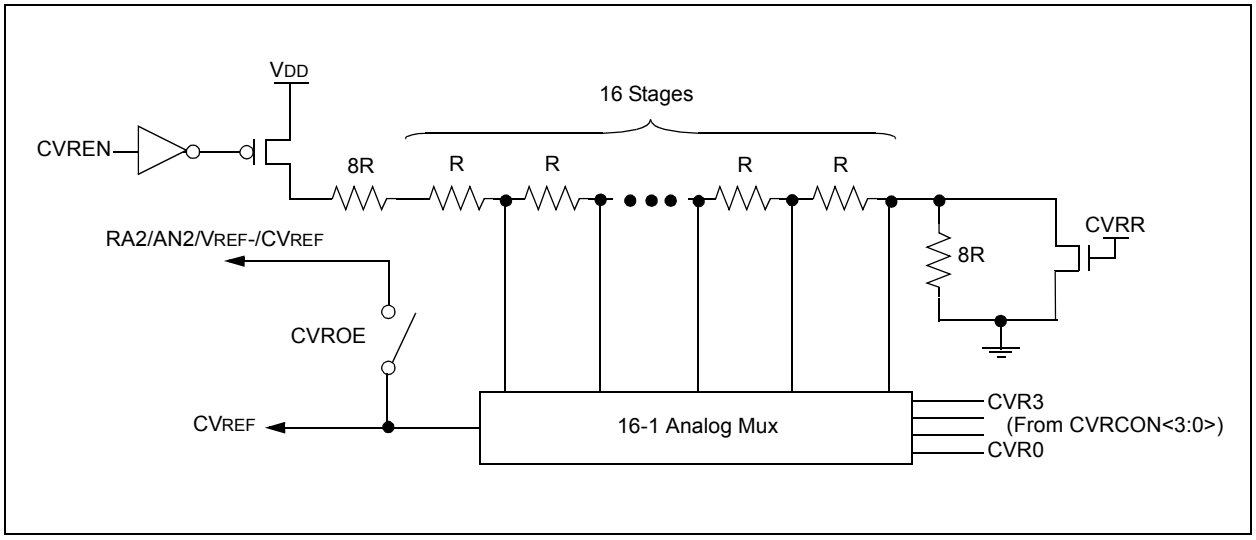


FIGURE 21-1: COMPARATOR VOLTAGE REFERENCE BLOCK DIAGRAM



21.2 Voltage Reference Accuracy/Error

The full range of voltage reference cannot be realized due to the construction of the module. The transistors on the top and bottom of the resistor ladder network (Figure 21-1) keep CVREF from approaching the reference source rails. The voltage reference is derived from VDD; therefore, the CVREF output changes with fluctuations in VDD. The tested absolute accuracy of the voltage reference can be found in **Section 26.0 "Electrical Characteristics"**.

21.3 Operation in Power-Managed Modes

The contents of the CVRCON register are not affected by entry to or exit from power-managed modes. To minimize current consumption in power-managed modes, the voltage reference module should be disabled; however, this can cause an interrupt from the comparators so the comparator interrupt should also be disabled while the CVRCON register is being modified.

21.4 Effects of a Reset

A device Reset disables the voltage reference by clearing the CVRCON register. This also disconnects the reference from the RA2 pin, selects the high-voltage range and selects the lowest voltage tap from the resistor divider.

21.5 Connection Considerations

The voltage reference module operates independently of the comparator module. The output of the reference generator may be output using the RA2 pin if the CVROE bit is set. Enabling the voltage reference output onto the RA2 pin, with an input signal present, will increase current consumption.

The RA2 pin can be used as a simple D/A output with limited drive capability. Due to the limited current drive capability, an external buffer must be used on the voltage reference output for external connections to VREF. Figure 21-2 shows an example buffering technique.

© 2007 Microchip Technology Inc.

TABLE 24-2: PIC18FXXX INSTRUCTION SET

Mnemonic, Operands		Description	Cycles	16-Bit Instruction Word MSb	LSb	Status Affected	Notes
BYTE-ORIENTED FILE REGISTER OPERATIONS							
ADDWF	f, d, a	Add WREG and f	1	0010 01da	ffff ffff	C, DC, Z, OV, N	1, 2
ADDWFC	f, d, a	Add WREG and Carry bit to f	1	0010 00da	ffff ffff	C, DC, Z, OV, N	1, 2
ANDWF	f, d, a	AND WREG with f	1	0001 01da	ffff ffff	Z, N	1,2
CLRF	f, a	Clear f	1	0110 101a	ffff ffff	Z	2
COMF	f, d, a	Complement f	1	0001 11da	ffff ffff	Z, N	1, 2
CPFSEQ	f, a	Compare f with WREG, Skip =	1 (2 or 3)	0110 001a	ffff ffff	None	4
CPFSGT	f, a	Compare f with WREG, Skip >	1 (2 or 3)	0110 010a	ffff ffff	None	4
CPFSLT	f, a	Compare f with WREG, Skip <	1 (2 or 3)	0110 000a	ffff ffff	None	1, 2
DECF	f, d, a	Decrement f	1	0000 01da	ffff ffff	C, DC, Z, OV, N	1, 2, 3, 4
DECFSZ	f, d, a	Decrement f, Skip if 0	1 (2 or 3)	0010 11da	ffff ffff	None	1, 2, 3, 4
DCFSNZ	f, d, a	Decrement f, Skip if Not 0	1 (2 or 3)	0100 11da	ffff ffff	None	1, 2
INCF	f, d, a	Increment f	1	0010 10da	ffff ffff	C, DC, Z, OV, N	1, 2, 3, 4
INCFSZ	f, d, a	Increment f, Skip if 0	1 (2 or 3)	0011 11da	ffff ffff	None	4
INFSNZ	f, d, a	Increment f, Skip if Not 0	1 (2 or 3)	0100 10da	ffff ffff	None	1, 2
IORWF	f, d, a	Inclusive OR WREG with f	1	0001 00da	ffff ffff	Z, N	1, 2
MOVF	f, d, a	Move f	1	0101 00da	ffff ffff	Z, N	1
MOVFF	f_s, f_d	Move f_s (source) to 1st word f_d (destination) 2nd word	2	1100 ffff 1111 ffff	ffff ffff ffff ffff	None	
MOVWF	f, a	Move WREG to f	1	0110 111a	ffff ffff	None	
MULWF	f, a	Multiply WREG with f	1	0000 001a	ffff ffff	None	
NEGF	f, a	Negate f	1	0110 110a	ffff ffff	C, DC, Z, OV, N	1, 2
RLCF	f, d, a	Rotate Left f through Carry	1	0011 01da	ffff ffff	C, Z, N	
RLNCF	f, d, a	Rotate Left f (No Carry)	1	0100 01da	ffff ffff	Z, N	1, 2
RRCF	f, d, a	Rotate Right f through Carry	1	0011 00da	ffff ffff	C, Z, N	
RRNCF	f, d, a	Rotate Right f (No Carry)	1	0100 00da	ffff ffff	Z, N	
SETF	f, a	Set f	1	0110 100a	ffff ffff	None	
SUBFWB	f, d, a	Subtract f from WREG with Borrow	1	0101 01da	ffff ffff	C, DC, Z, OV, N	1, 2
SUBWF	f, d, a	Subtract WREG from f	1	0101 11da	ffff ffff	C, DC, Z, OV, N	
SUBWFB	f, d, a	Subtract WREG from f with Borrow	1	0101 10da	ffff ffff	C, DC, Z, OV, N	1, 2
SWAPF	f, d, a	Swap Nibbles in f	1	0011 10da	ffff ffff	None	4
TSTFSZ	f, a	Test f, Skip if 0	1 (2 or 3)	0110 011a	ffff ffff	None	1, 2
XORWF	f, d, a	Exclusive OR WREG with f	1	0001 10da	ffff ffff	Z, N	
BIT-ORIENTED FILE REGISTER OPERATIONS							
BCF	f, b, a	Bit Clear f	1	1001 bbba	ffff ffff	None	1, 2
BSF	f, b, a	Bit Set f	1	1000 bbba	ffff ffff	None	1, 2
BTFSC	f, b, a	Bit Test f, Skip if Clear	1 (2 or 3)	1011 bbba	ffff ffff	None	3, 4
BTFSS	f, b, a	Bit Test f, Skip if Set	1 (2 or 3)	1010 bbba	ffff ffff	None	3, 4
BTG	f, d, a	Bit Toggle f	1	0111 bbba	ffff ffff	None	1, 2

Note 1: When a PORT register is modified as a function of itself (e.g., `MOVF PORTB, 1, 0`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

2: If this instruction is executed on the TMR0 register (and where applicable, d = 1), the prescaler will be cleared if assigned.

3: If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

4: Some instructions are 2-word instructions. The second word of these instructions will be executed as a NOP unless the first word of the instruction retrieves the information embedded in these 16 bits. This ensures that all program memory locations have a valid instruction.

5: If the table write starts the write cycle to internal memory, the write will continue until terminated.

© 2007 Microchip Technology Inc.

BCF **Bit Clear f**

Syntax: [*label*] BCF f,b[,a]

Operands: $0 \le f \le 255$
$0 \le b \le 7$
$a \in [0,1]$

Operation: $0 \rightarrow f<b>$

Status Affected: None

Encoding:

1001	bbba	ffff	ffff

Description: Bit 'b' in register 'f' is cleared. If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BCF FLAG_REG, 7`

Before Instruction
FLAG_REG = 0xC7
After Instruction
FLAG_REG = 0x47

BN **Branch if Negative**

Syntax: [*label*] BN n

Operands: $-128 \le n \le 127$

Operation: if Negative bit is '1',
(PC) + 2 + 2n → PC

Status Affected: None

Encoding:

1110	0110	nnnn	nnnn

Description: If the Negative bit is '1', then the program will branch.
The 2's complement number '2n' is added to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is then a two-cycle instruction.

Words: 1

Cycles: 1(2)

Q Cycle Activity:
If Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	Write to PC
No operation	No operation	No operation	No operation

If No Jump:

Q1	Q2	Q3	Q4
Decode	Read literal 'n'	Process Data	No operation

Example:
```
HERE    BN   Jump
```

Before Instruction
PC = address (HERE)
After Instruction
If Negative = 1;
PC = address (Jump)
If Negative = 0;
PC = address (HERE + 2)

© 2007 Microchip Technology Inc.

INCFSZ **Increment f, Skip if 0**

Syntax: [*label*] INCFSZ f [,d [,a]]

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (f) + 1 → dest,
skip if result = 0

Status Affected: None

Encoding:

0011	11da	ffff	ffff

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).
If the result is '0', the next instruction which is already fetched is discarded and a NOP is executed instead, making it a two-cycle instruction. If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    INCFSZ   CNT
NZERO   :
ZERO    :
```

Before Instruction
PC = Address (HERE)

After Instruction
CNT = CNT + 1
If CNT = 0;
PC = Address (ZERO)
If CNT ≠ 0;
PC = Address (NZERO)

INFSNZ **Increment f, Skip if Not 0**

Syntax: [*label*] INFSNZ f [,d [,a]]

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (f) + 1 → dest,
skip if result ≠ 0

Status Affected: None

Encoding:

0100	10da	ffff	ffff

Description: The contents of register 'f' are incremented. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is placed back in register 'f' (default).
If the result is not '0', the next instruction which is already fetched is discarded and a NOP is executed instead, making it a two-cycle instruction. If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' = 1, then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1(2)
Note: 3 cycles if skip and followed by a 2-word instruction.

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

If skip:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation

If skip and followed by 2-word instruction:

Q1	Q2	Q3	Q4
No operation	No operation	No operation	No operation
No operation	No operation	No operation	No operation

Example:
```
HERE    INFSNZ   REG
ZERO
NZERO
```

Before Instruction
PC = Address (HERE)

After Instruction
REG = REG + 1
If REG ≠ 0;
PC = Address (NZERO)
If REG = 0;
PC = Address (ZERO)

© 2007 Microchip Technology Inc.

XORWF **Exclusive OR W with f**

Syntax: [*label*] XORWF f [,d [,a]]

Operands: $0 \le f \le 255$
$d \in [0,1]$
$a \in [0,1]$

Operation: (W) .XOR. (f) → dest

Status Affected: N, Z

Encoding:

0001	10da	ffff	ffff

Description: Exclusive OR the contents of W with register 'f'. If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in the register 'f' (default). If 'a' is '0', the Access Bank will be selected, overriding the BSR value. If 'a' is '1', then the bank will be selected as per the BSR value (default).

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: XORWF REG

Before Instruction
REG = 0xAF
W = 0xB5

After Instruction
REG = 0x1A
W = 0xB5

26.2 DC Characteristics: Power-Down and Supply Current PIC18F2220/2320/4220/4320 (Industrial) PIC18LF2220/2320/4220/4320 (Industrial) (Continued)

PIC18LF2220/2320/4220/4320 (Industrial)		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
PIC18F2220/2320/4220/4320 (Industrial, Extended)		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Param No.	**Device**	**Typ**	**Max**	**Units**	**Conditions**		
	Supply Current (IDD)(2,3)						
	PIC18LF2X20/4X20	100	220	µA	-40°C	VDD = 2.0V	FOSC = 1 MHz (**RC_RUN** mode, internal oscillator source)
		110	220	µA	+25°C		
		120	220	µA	+85°C		
	PIC18LF2X20/4X20	180	330	µA	-40°C	VDD = 3.0V	
		180	330	µA	+25°C		
		170	330	µA	+85°C		
	All devices	340	550	µA	-40°C	VDD = 5.0V	
		330	550	µA	+25°C		
		310	550	µA	+85°C		
	Extended devices	410	650	µA	+125°C		
	PIC18LF2X20/4X20	350	600	µA	-40°C	VDD = 2.0V	FOSC = 4 MHz (**RC_RUN** mode, internal oscillator source)
		360	600	µA	+25°C		
		370	600	µA	+85°C		
	PIC18LF2X20/4X20	580	900	µA	-40°C	VDD = 3.0V	
		580	900	µA	+25°C		
		560	900	µA	+85°C		
	All devices	1.1	1.8	mA	-40°C	VDD = 5.0V	
		1.1	1.8	mA	+25°C		
		1.0	1.8	mA	+85°C		
	Extended devices	1.2	1.8	mA	+125°C		

Legend: Shading of rows is to assist in readability of the table.

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in high-impedance state and tied to VDD or VSS and all features that add delta current disabled (such as WDT, Timer1 Oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD;

$\overline{\text{MCLR}}$ = VDD; WDT enabled/disabled as specified.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be estimated by the formula Ir = VDD/2REXT (mA) with REXT in kΩ.

4: Standard low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

26.4.3 TIMING DIAGRAMS AND SPECIFICATIONS

FIGURE 26-6: EXTERNAL CLOCK TIMING (ALL MODES EXCEPT PLL)

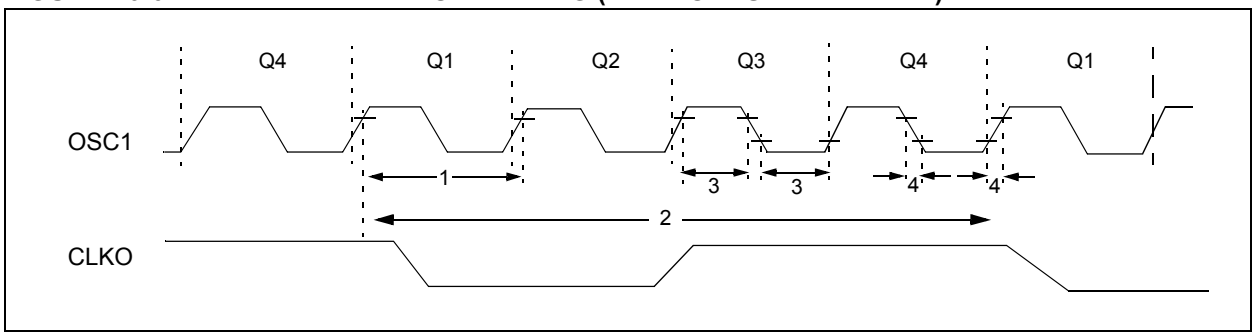


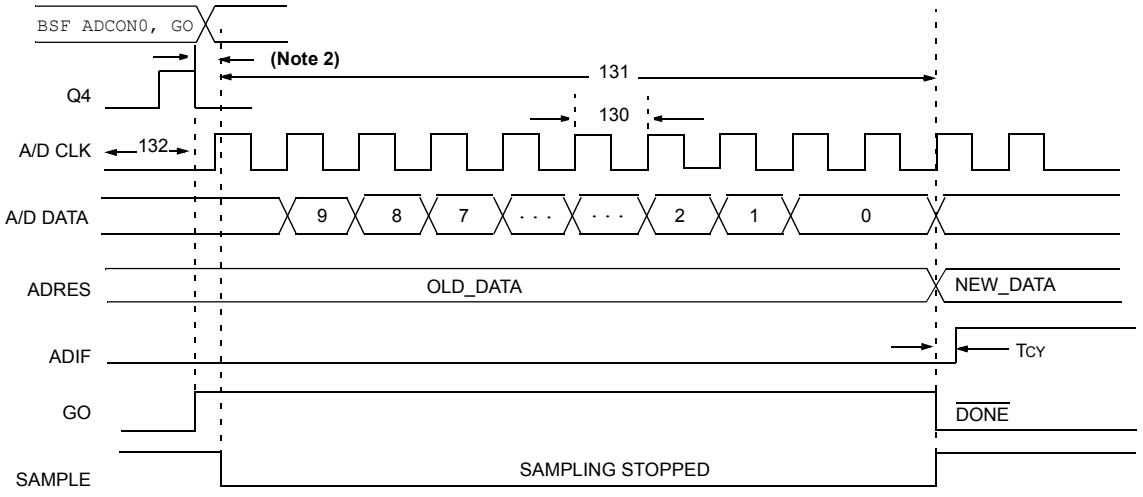
TABLE 26-6: EXTERNAL CLOCK TIMING REQUIREMENTS

Param. No.	Symbol	Characteristic	Min	Max	Units	Conditions
1A	FOSC	External CLKI Frequency(1)	DC	40	MHz	EC, ECIO (industrial)
			DC	25	MHz	EC, ECIO (extended)
		Oscillator Frequency(1)	DC	4	MHz	RC osc
			0.1	1	MHz	XT osc
			4	25	MHz	HS osc
			4	10	MHz	HS + PLL osc (industrial)
			4	6.25	MHz	HS + PLL osc (extended)
			5	33	kHz	LP Osc mode
1	TOSC	External CLKI Period(1)	25	—	ns	EC, ECIO (industrial)
			40	—	ns	EC, ECIO (extended)
		Oscillator Period(1)	250	—	ns	RC osc
			1	—	μs	XT osc
			40	250	ns	HS osc
			100	250	ns	HS + PLL osc (industrial)
			160	250	ns	HS + PLL osc (extended)
			30	—	μs	LP osc
2	TCY	Instruction Cycle Time(1)	100	—	ns	TCY = 4/FOSC (industrial)
			160	—	ns	TCY = 4/FOSC (extended)
3	TOSL, TOSH	External Clock in (OSC1) High or Low Time	30	—	ns	XT osc
			2.5	—	μs	LP osc
			10	—	ns	HS osc
4	TOSR, TOSF	External Clock in (OSC1) Rise or Fall Time	—	20	ns	XT osc
			—	50	ns	LP osc
			—	7.5	ns	HS osc

Note 1: Instruction cycle period (TCY) equals four times the input oscillator time base period for all configurations except PLL. All specified values are based on characterization data for that particular oscillator type under standard operating conditions with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at “min.” values with an external clock applied to the OSC1/CLKI pin. When an external clock input is used, the “max.” cycle time limit is “DC” (no clock) for all devices.

© 2007 Microchip Technology Inc.

FIGURE 26-23: A/D CONVERSION TIMING



Note 1: If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

TABLE 26-25: A/D CONVERSION REQUIREMENTS

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
130	TAD	A/D Clock Period	PIC18**F**XX20	1.6	20(2)	µs	TOSC based, VREF ≥ 3.0V
			PIC18**LF**XX20	3.0	20(2)	µs	TOSC based, VREF full range
			PIC18**F**XX20	2.0	6.0	µs	A/D RC mode
			PIC18**LF**XX20	3.0	9.0	µs	A/D RC mode
131	TCNV	Conversion Time (not including acquisition time)(1)		11	12	TAD	

Note 1: ADRES register may be read on the following TCY cycle.

2: The time of the A/D clock period is dependent on the device frequency and the TAD clock divider.

© 2007 Microchip Technology Inc.

FIGURE 27-3: MAXIMUM IDD vs. FOSC OVER VDD PRI_RUN, EC MODE, -40°C TO +125°C

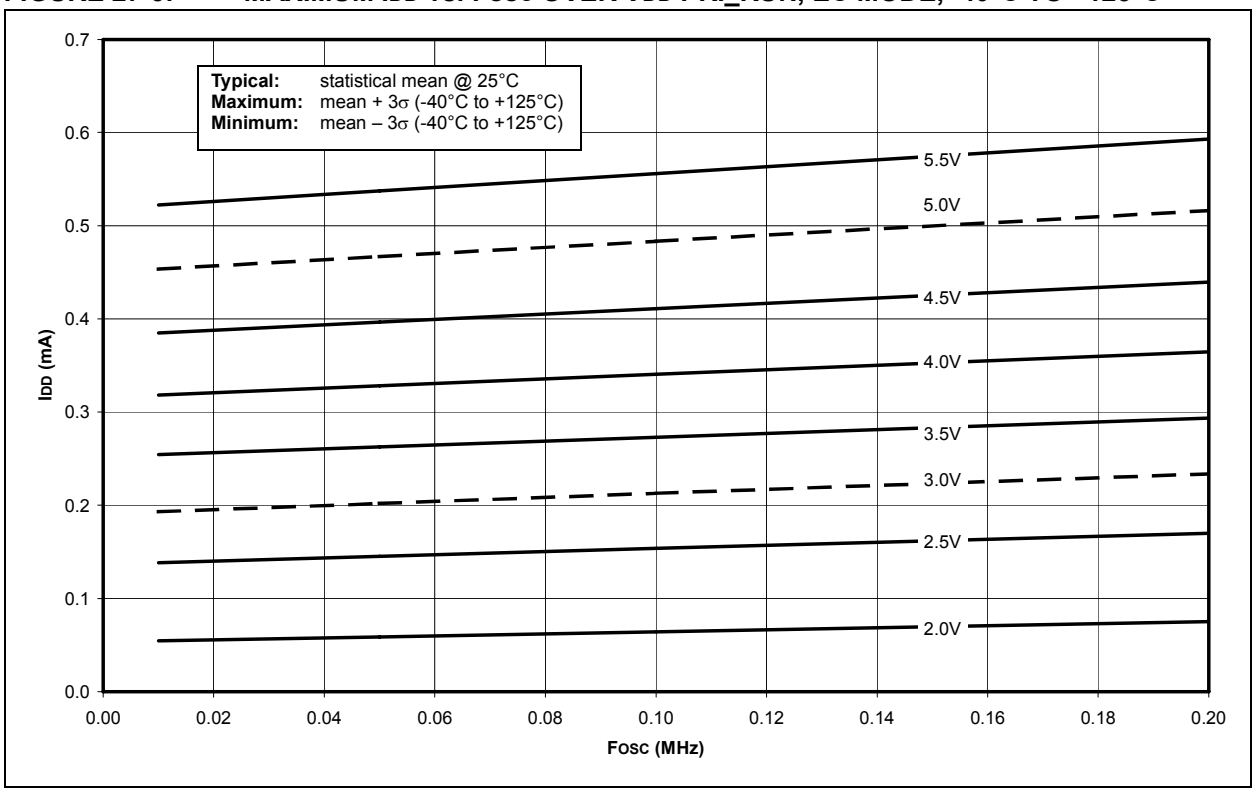
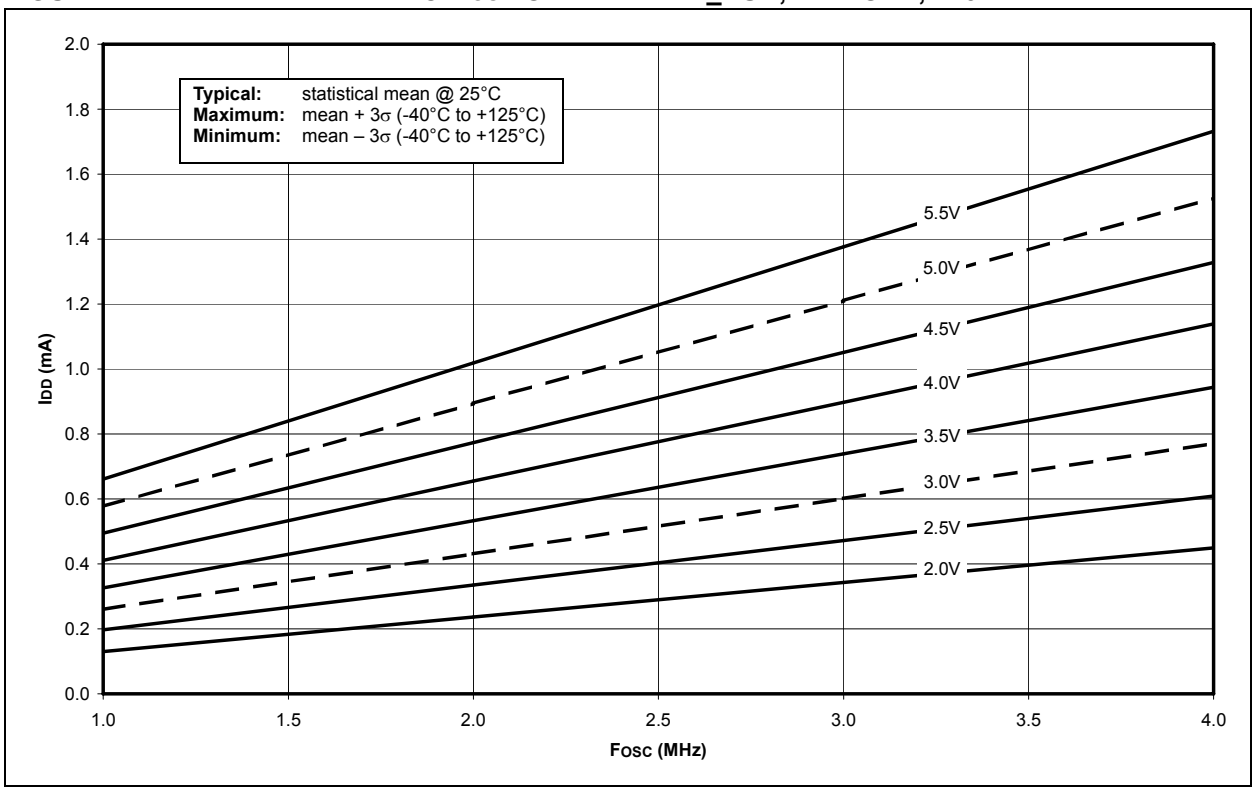


FIGURE 27-4: TYPICAL IDD vs. FOSC OVER VDD PRI_RUN, EC MODE, +25°C



© 2007 Microchip Technology Inc.

C

D

© 2007 Microchip Technology Inc.

© 2007 Microchip Technology Inc.